

Cement Power Resistors

FEATURES

- 5% tolerance
- · Exceptionally small, sturdy, and reliable
- · Sealed with a special cement
- · Excellent moisture resistance
- High temperature stability
- · Ceramic flame retardant package
- · Recommended wash method is alcohol

DERATING CHART



PART NUMBERING SYSTEM





SERIES, WATTAGE, VALUE RANGE, AND DIMENSIONS

Series	Watts (W)	Range of V	Values (Ω)			Dimensions (mm)		
Series	walls (w)	Wirewound	Power Film	W ±1	D ±1	L±1	ød ±0.05	P ±1
* PRM	5	0.1 ~ 47	48 ~ 100K	12.5	9	25	0.75	5
PRM	7	0.1 ~ 680	681 ~ 200K	12.5	9	38	0.75	5
PRM	10	0.1 ~ 910	911 ~ 200K	12.5	9	50	0.75	5

HEAT RISE CHART

20

60

Rated Load (%)

40

80

100

140

120

100

80

60

40

20

0

0

Heat Rise (°C)

* Leads are centered

STANDARD STOCKED VALUES (Ω) All standard E-24 values not listed are available special order.

0.1	0.3	0.51	1.0	3.0	6.8	15	33	56	68	75	100	150	200	300	330	470	680	1K	2K	4.7K	10K
0.22	0.47	0.68	2.2	4.7	10	20	47														

CONSTRUCTION

No.	Subpart Name	Material	Material Generic Name	5 6 3
1	Body	Rod Type Ceramics	Al ₂ O ₃ , SiO ₂	
2	End Cap	Tin plated iron surface	Tin : 5%, Iron : 95%	Cement: Wire-wound
3	Lead	Annealed copper wire	Tin-Coated Copper wire	
		(Electrosolder plated surface) Pb Free		- 563
4	Ceramic Case	Ceramic	Al ₂ O ₃ , SiO ₂	
5	Resistance wire	Ni-Cr Alloy	Ni-Cr Alloy	Cement: Power Film
	Resistance Film	Metal Oxide Film	Metal Oxide Film	
6	Filling Materials	Quartz mixed sand	SiO2	4 1 2

XICON

XICON PASSIVE COMPONENTS · (800) 628-0544



5W, 7W, 10W

зW

2W



PRM Series



Cement Power Resistors

CHARACTERISTICS

Characteristics	Limits		Test Methods (JIS C 5201-1)						
Temperature coefficient				5.2 Natural resistance change per temp. degree centigrade. R2-R1 x10° (PPM / °C) R1(t2-t1) R1: Resistance value at room temperature (t1) R2: Resistance value at room temp. plus 100 °C (t2)					
Dielectric withstanding voltage	No evidence of flashov mechanical damage, a or insulation break dov	rcing	5.7 Resistors shall be clamped in the trough of a 90° metallic V-block and shall be tested at AC potential respectively for 60 +10/ -0 secs.						
			7.4 Resistance change after continuous 5 cycles for duty shown below:						
Temperature	Resistance change rat	e is	Step	Temperature	Time				
cycling	$\pm (2\% + 0.05\Omega)$ Max. v	-	1	-55 °C ± 3 °C	30 mins				
-,	evidence of mechanica	-	2	Room temp.	10 ~ 15 mins				
			3	+155 °C ± 2 °C	30 mins				
		-	4	Room temp.	10 ~ 15 mins				
	Resistance change rat								
Short time	$\pm (5\% + 0.05\Omega)$ Max. v		5.5 Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds 7.9 Resistance change after 1,000 hours						
overload	evidence of mechanica								
ovendau									
	Resistance value	∆ R/R			3				
	Wire-wound	± 5%		operating at RCWV with duty cycle of					
Load life in humidity	Power film: <100ΚΩ >100ΚΩ	± 5% ± 10%	(1.5 hours "on", 0.5 hour "off") in a humidity test chamber controlled at 40 °C \pm 2 °C and 90 to 95 % relative humidity						
	Resistance value	∆ R/R	7.10 Permanent resistance change after						
Load life	Wire-wound	± 5%	1,000 hours operating at RCWV with duty cycle						
	Power film: <100KΩ	± 5%	of (1.5 hours "o	n", 0.5 hour "off")					
	>100ΚΩ	± 10%	at 70 °C ±2 °C						
Terminal strength	No evidence of mecha damage	nical	 6.1 Direct load : Resistance to a 2.5 kgs direct load for 10 secs. in the direction of the longitudinal axis of the terminal leads Twist test : Terminal leads shall be bent through 90 ° at a point of about 6mm from the body of the resistor and shall be rotated through 360° about the original axis of the bent terminal in alternating direction for a total of 3 rotations 						
Resistance to soldering heat	Resistance change rat \pm (1% + 0.05 Ω) Max. v evidence of mechanica	vith no	6.4 Permanent resistance change when leads immersed to 3.2 to 4.8 mm from the body in $350 ^\circ\text{C} \pm 10 ^\circ\text{C}$ solder for 3 ± 0.5 secs.						
Solderability	95 % coverage Min.		6.5 The area covered with a new , smooth clean , shiny and continuous surface free from concentrated pinholes. Test temp. of solder : 245 °C ± 3 °C Dwell time in solder : 2 ~ 3 seconds						



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